Itorney Docket No. P117-US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Schaadt, et al.

Art Unit: 1765

Serial No.:

10/666,998

Examiner: Not Yet Assigned

Filed: 9/17/03

For: AN ETCHING METHOD IN FABRICATIONS OF MICROSTRUCTURES

INFORMATION DISCLOSURE STATEMENT PURSUANT TO 37 CFR 1.97(b)

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-145

Sir:

The attention of the Patent and Trademark Office is hereby directed to the documents listed on the attached PTO Form 1449. Copies of the cited references are enclosed.

No fee or certification is required in connection with this Information Disclosure Statement, since it is being submitted prior to the last of (1) issuance of a first official action on the merits and (2) expiration of the three month period following filing of the above-captioned application.

The above information is presented so that the Patent and Trademark Office can determine any materiality thereof to the claimed invention. It is respectfully requested that the information be considered during the prosecution of this application and that the cited documents be listed on the front page of any patent issuing from this application.

The Patent Office is authorized to charge our Deposit Account No. 501516 for any fee which it deems to be required to effect consideration of this statement.

Respectfully submitted,

Gregory R. Mair

Attorney for Applicant(s) Registration No. 35,293

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Complete if Known Substitute for form 1449A/PTO **Application Number** 10/666,998 INFORMATION DISCLOSURE 9/17/03 Filing Date STATEMENT BY APPLICANT First Named Inventor Schaadt 1765 Art Unit (use as many sheets as necessary) Not Yet Assigned Examiner Name of Attorney Docket Number P117-US

			U.S. PAT	ENT DOCUMENTS	
Examiner Initials	1	Document Number Number- Kind Code ² (if known	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
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				Application Number	10/666,998
INFO	RMATION	DI	SCLOSURE	Filing Date	9/17/03
STA	TEMENT B	Y	APPLICANT	First Named Inventor	Schaadt
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Sheet	2	of	6	Attorney Docket Number	P117-US

		U.S. PAT	ENT DOCUMENTS	
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Complete if Known 10/666,998 **Application Number** 9/17/03 Filing Date Schaadt First Named Inventor 1765 Group Art Unit Not Yet Assigned Examiner Name P117-US Attorney Docket Number

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		OTHER PRIOR ART NON PATENT LITERATURE DOCUMENTS	_
Examiner Initials	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	
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Sheet	6	of	6	Attorney Docket Number	P117-US	

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unuais	NO.	number(s), publisher, city and/or country where published SEBEL et al., "Reaction Layer Dynamics in Ion-Assisted Si/XeF2 Etching: Temperature Dependence", J. Vac. Sci. Technol. A, Vac. Surf. Films, Vol. 18, No. 6, (Nov. 2000), pp. 2759-2769 (abstract only).	
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